



# Product Change Notification

**Change Notification #:** 118828-00  
**Change Title:** Select Server Chassis R2000WFXXX,  
 PCN 118828-00, Label,  
 Updates to Regulatory & Packaging Labels  
**Date of Publication:** January 7, 2022

**Key Characteristics of the Change:**  
 Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*</b>	February 04, 2022
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

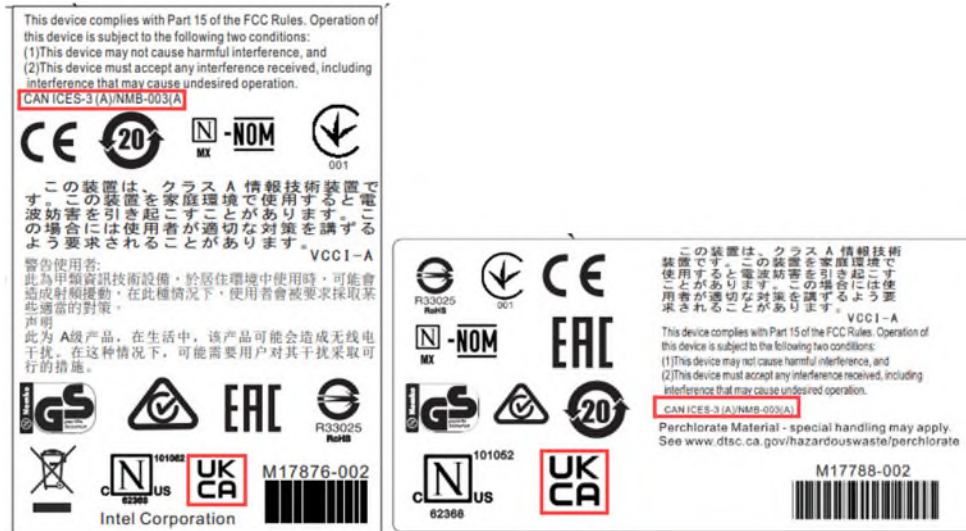
Intel is implementing the following change on the items listed in the “Products Affected” table.

- Adding the UKCA logo
- Updating Canada logos

## Labels Before



## Labels After



(All images for example only)

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server Chassis R2000WFXXX	R2000WFXXX	975897	H97485-008	H97485-009

## PCN Revision History:

**Date of Revision:**

January 7, 2022

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

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